## Tuning the Gallium Content of Metal Precursors for Cu(In,Ga)Se<sub>2</sub> Thin Film Solar Cells by Electrodeposition from a Deep Eutectic Solvent

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(1) We present the mathematical development that via the mass fluxes (J), the Ga/III ratio of the deposits can be controlled.

According to Fick's Law, during codeposition of two elements, in a system under diffusion control, the composition of a deposit is dictated by the ratio of the mass fluxes, *J*. Therefore,for In and Ga one can write:

$$\frac{J_{Ga}}{J_{In}} = \left(\frac{n_{Ga}}{n_{In}}\right)_{deposit} \tag{1}$$

a) Considering  $J_{Ga}/J_{In} = A$  one can prove that:

$$\frac{Ga}{Ga+In} = \frac{Ga}{III} = \frac{A}{A+1}$$
(2)

This equation establishes a relation between the mass fluxes and the expected Ga/III ratio, thus evidencing, theoretically, that via the mass fluxes one can control this ratio. The next steps will focus on proving that the charge passed during deposition, *Q*, ensures the desired stoichiometry.

When performing electrodeposition of two different species, the total current flowing,  $j_t$ , is the sum of the individual currents. Thus, in our system the currents generated by the reduction of In and Ga during deposition:

$$j_t = j_{In} + j_{Ga} \tag{3}$$

b) Therefore, by integration in time, one obtains the charge, Q:

$$Q_t = \int_0^t j_{In} dt + \int_0^t j_{Ga} dt \tag{4}$$

Since the deposition is performed under a diffusion control regime and the working electrode is rotated, any time dependent behaviour of the current is eliminated and one can directly write:

$$Q_t = Q_{In} + Q_{Ga} \tag{5}$$

c) Using Faraday's Law, one can write explicitly both components of Q<sub>t</sub>.

$$Q_{In} = \frac{kFn_{In}}{\eta} \tag{6}$$

$$Q_{Ga} = \frac{kFn_{Ga}}{\eta} \tag{7}$$

Where *k* is the number of transferred electrons, *F* is the Faraday constant (96485 C.mol<sup>-1</sup>), *n* is the number of moles deposited (mol) and  $\eta$  is the plating efficiency. The latter variable will be considered 90% for both species.

d) One can then write:

$$Q_{Ga} = Q_{In} \cdot \frac{n_{Ga}}{n_{In}} \Leftrightarrow Q_{Ga} = Q_{In} \cdot \frac{J_{Ga}}{J_{In}}$$
(8)

$$Q_t = Q_{In} \left( 1 + \frac{J_{Ga}}{J_{In}} \right) \tag{9}$$

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Equation 9 shows the total charge passed during deposition will be divided into 2 components, where the latter is related to Ga and includes a correction term  $J_{Ga}/J_{In}$  which ensures the expected stoichiometry of the deposit.



Expected and measured CVs of ChCI:U-GaCl<sub>3</sub>-InCl<sub>3</sub> on a Mo electrode with Ga/III = a) 0.3, b) 0.7 and c) 0.9. The expected CVs were calculated from the sum of the single element systems ChCI:U-GaCl<sub>3</sub> and ChCI:U-InCl<sub>3</sub> on a Mo electrode. All CVs were baseline corrected.